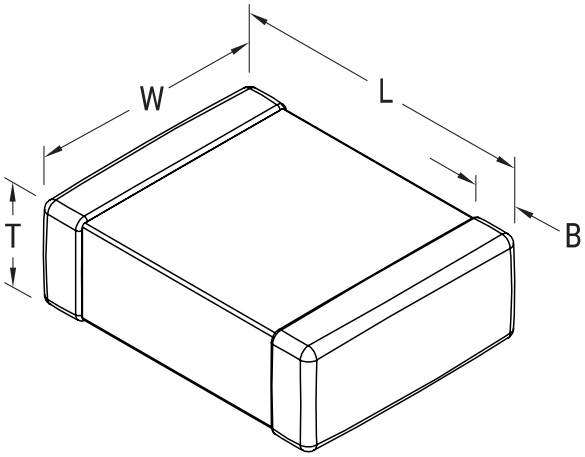
# CBR06C879B5GAC

CBR-SMD RF C0G, Ceramic, 8.7 pF, +/-0.1 pF, 50 VDC, C0G, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603 / 1608




Click here for the 3D model.

| General Information | |
|---|---|
| Series | CBR-SMD RF C0G |
| Style | SMD Chip |
| Description | SMD, Fixed, RF, Ultra High Q, Low ESR, Class I |
| Features | Ultra High Q, Low ESR, Class I |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| Typical Component Weight | 5.29 mg |
| Notes | Solder Wave or Solder Reflow. |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Dimensions | |
|---|---|
| L | 1.6mm +/-0.1mm |
| W | 0.8mm +/-0.1mm |
| T | 0.8mm +/-0.07mm |
| B | 0.4mm +/-0.15mm |
| Case Code (EIA / mm) | 0603 / 1608 |

| Packaging Specifications | |
|---|---|
| Packaging | T&R, 180mm, Plastic Tape |
| Packaging Quantity | 4000 |

| Specifications | |
|---|---|
| Capacitance | 8.7 pF |
| Tolerance | +/-0.1 pF |
| Voltage DC | 50 VDC |
| Dielectric Withstanding Voltage | 125 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | C0G |
| Dissipation Factor | 0.174% |
| Aging Rate | 0% Loss/Decade Hour |
| Insulation Resistance | 10 GOhms |
| Quality Factor | 574 |

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